SiZ342DDT

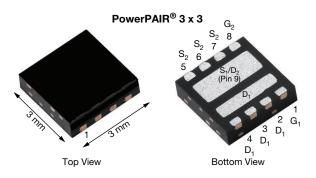
RoHS

COMPLIANT

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Vishay Siliconix

Dual N-Channel 30 V (D-S) MOSFET



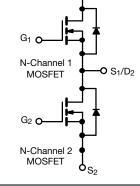
PRODUCT SUMMARY					
V _{DS} (V)	30				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0092				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.0155				
Q _g typ. (nC)	3.7				
I _D (A)	33.6 ^a				
Configuration	Dual				

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- High side and low side MOSFETs form optimized combination for 50 % duty cycle
- Optimized R_{DS} Q_g and R_{DS} Q_{gd} FOM elevates efficiency for high frequency switching
- 100 % R_{α} and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Synchronous buck
- DC/DC conversion
- Half bridge
- POL



ORDERING INFORMATION	
Package	PowerPAIR 3 x 3
Lead (Pb)-free and halogen-free	SiZ342DDT-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	30	N	
Gate-source voltage		V _{GS}	+20 / -16	V	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		33.6		
	T _C = 70 °C		26.9		
	T _A = 25 °C	I _D	15.8 ^{b, c}		
	T _A = 70 °C		12.6 ^{b, c}		
Pulsed drain current (t = 100 µs)	I _{DM}	100	— A		
Continuous source current (MOSFET diode conduction)	T _C = 25 °C		13.9		
	T _A = 25 °C	I _S	3.1 ^{b, c}		
Single pulse avalanche current	1 0.1 mll	I _{AS}	10		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	5	mJ	
	T _C = 25 °C		16.7		
Maximum power dissipation	T _C = 70 °C	P	10.7	w	
	T _A = 25 °C	P _D	3.7 ^{b, c}		
	T _A = 70 °C		2.4 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature)			260		

Notes

a. T_C = 25 °C

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

S24-0448-Rev. A, 29-Apr-2024

1



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THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, b	t ≤ 10 s	R _{thJA}	27	34	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	6	7.5		

Notes

a. Surface mounted on 1" x 1" FR4 board

b. Maximum under steady state conditions is 69 °C/W

SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless othe	rwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	•						
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	30	-	-	N	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.1	-	2.4	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = +20 V / -16 V$	-	-	± 100	nA	
Zere esta alla estate estate		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	•	
Zero gate voltage drain current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	5	μA	
Drain acuras en stata registance à	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0075	0.0092	0	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$	-	0.012	0.0155	Ω	
Forward transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 10 A	-	23	-	S	
Dynamic ^b							
Input capacitance	C _{iss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	500	-	pF	
Output capacitance	C _{oss}		-	230	-		
Reverse transfer capacitance	C _{rss}		-	30	-		
C _{rss} /C _{iss} ratio			-	0.062	0.12		
Tatal asta abaura	0	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$	-	8.4	12.6		
Total gate charge	Qg	V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 15 A	-	4	6	nC	
Gate-source charge	Q _{gs}		-	2.2	-		
Gate-drain charge	Q _{gd}		-	1.0	-		
Gate resistance	Rg	f = 1 MHz	0.2	1.2	2	Ω	
Turn-on delay time	t _{d(on)}		-	10	20	ns	
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 1.5 \Omega, \text{ I}_{D} \cong 10 \text{ A},$	-	20	40		
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	13	25		
Fall time	t _f		-	5	10		
Turn-on delay time	t _{d(on)}		-	12	25		
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega, \text{ I}_{\text{D}} \cong 10 \text{ A},$	-	100	200		
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	10	20		
Fall time	t _f		-	10	20		
Drain-source Body Diode Characterist	ics		•				
Continuous source-drain diode current	I _S	T _C = 25°C	-	-	13.9		
Pulse diode forward current	I _{SM}		-	-	100	A	
Body diode voltage	V _{SD}	I _S = 8 A, V _{GS} = 0 V	-	0.83	1.2	V	
Body diode reverse recovery time	t _{rr}		-	15	30	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	4	10	nC	
Reverse recovery fall time	ta	$T_J = 25 \ ^{\circ}C$	-	7.5	-		
Reverse recovery rise time	t _b	1 F	-	7.5	-	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

S24-0448-Rev. A, 29-Apr-2024

2



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T_C = -55 °C

3

2

10

15

Capacitance

T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

20

V_{GS} = 10 V

V_{GS} = 4.5 V

25

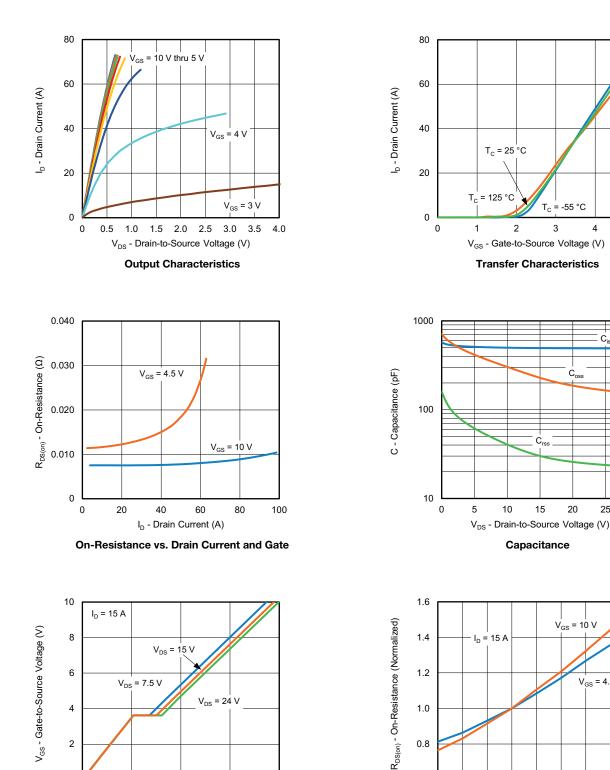
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C_{ie}

5

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



100 125 150

S24-0448-Rev. A, 29-Apr-2024

2

4

Q_q - Total Gate Charge (nC)

Gate Charge

6

8

0 0

> 3 For technical questions, contact: pmostechsupport@vishay.com

0.6

-50

-25 0 25 50 75

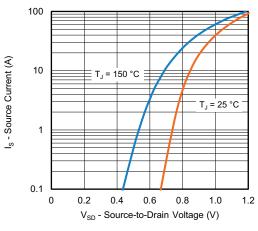
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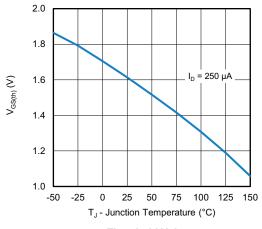


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

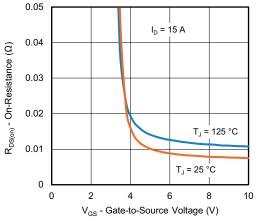


Source-Drain Diode Forward Voltage

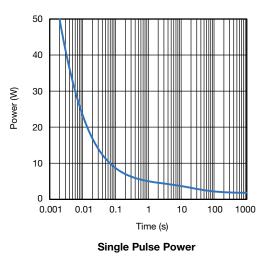


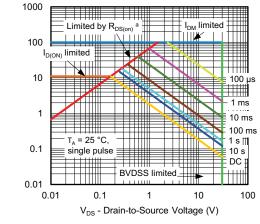


l_D - Drain Current (A)



On-Resistance vs. Gate-to-Source Voltage





Safe Operating Area, Junction-to-Ambient

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

S24-0448-Rev. A, 29-Apr-2024

4

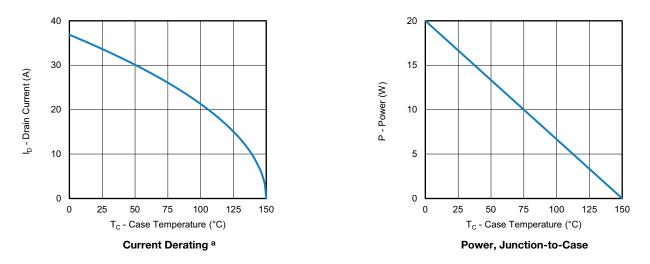
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



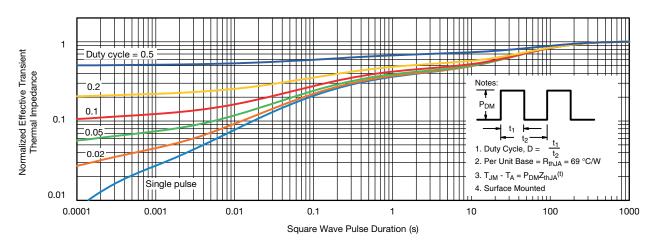
Notes

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-ambient thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

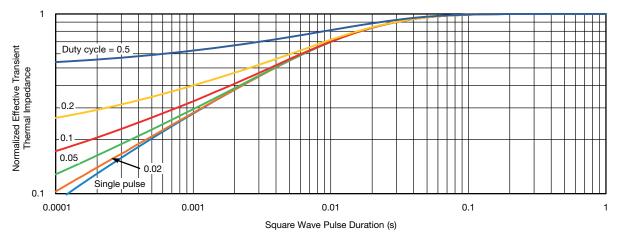


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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6



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